

LSU PROMASK 16

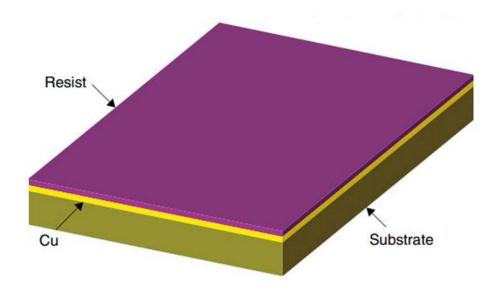
Final Design Review

Scott Brown Cody Dougherty Alexandra Harmon Cody Miller Deanna Petty



BACKGROUND

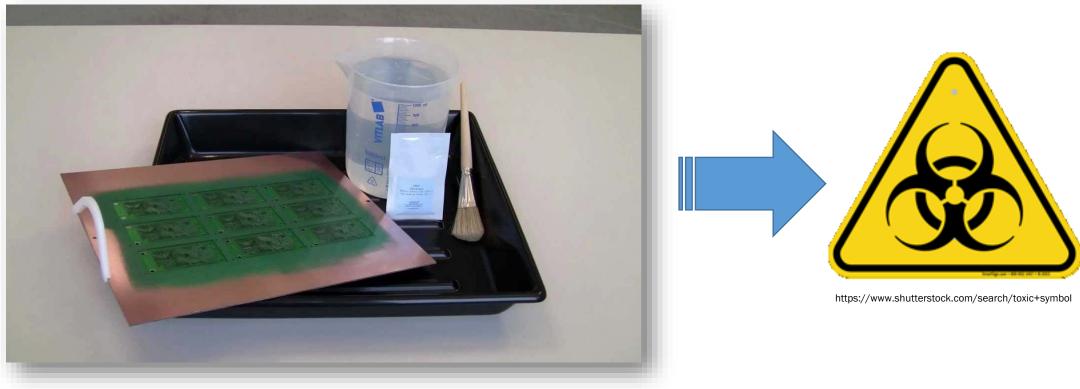
- Contemporary Fabrication
 - LPISM
 - Application
 - Production



https://nguyenhieuhobby.wordpress.com/2012/11/26/mot-so-khai-niem-trong-thiet-ke-mach-in/



Problem Statement



https://www.youtube.com/watch?v=Ps8aPpW_PEA

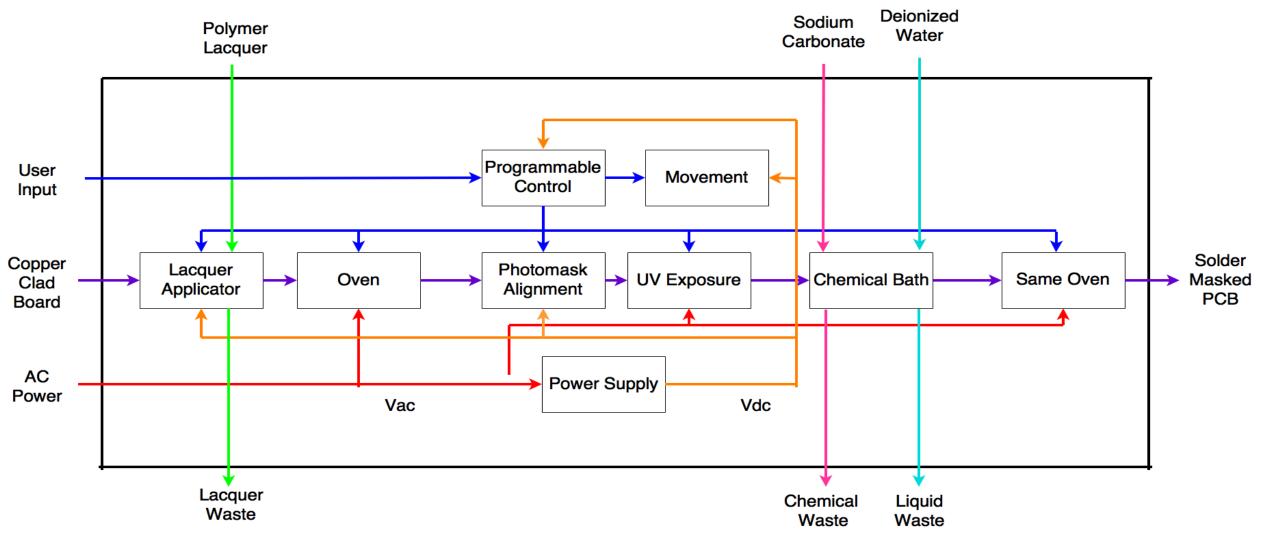


Process Summary

- 1. Lacquer Application
- 2. Exposing System
- 3. Chemical Rinse Bays
- 4. Thermal Curing System
- 5. Building Frame
- 6. Controls
- 7. Power
- 8. PCB Results
- 9. Project Budget Analysis



Overall Design Functionality





Marketing Requirements		Marketing	Justification		
1, 3, 4, 6	Solde		l on qualification and performance of anent solder mask (IPC-SM-840C)		
1, 3, 4, 6, 7	The s than	Requirements	ven needs to function at high temperatures er to harden the solder mask enough		
1,2, 3	The s	1. Chemical containment and safety	uring process the UV must be exposing		
1	The s carbc mask	 Desktop size through a compact design Automated design 	y recise etching technique to be fulfilled.		
4, 7	The s	 4. Industry level quality 5. Intuitive user interface 	rials of system must be quality of main manufacturers		
1, 2, 3	The s latera	6. High reliability	ms need to fit compactly in lab onment.		
3, 6, 7	The s	7. Maintainability	y connect to wall outlets in lab environment.		
5, 6, 7	The s users		users of machine's functionality operation.		



Lacquer Application System





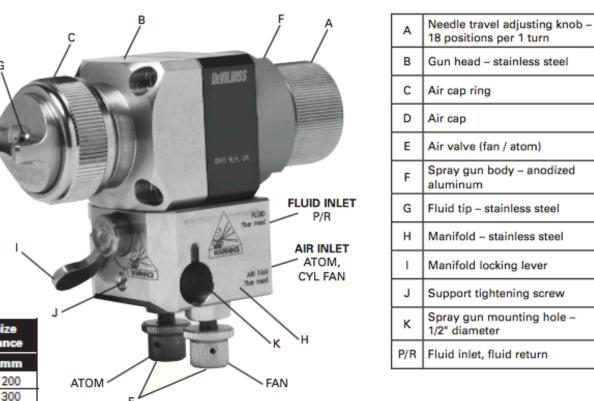




DeVilbiss Trans-Tech Spray Gun

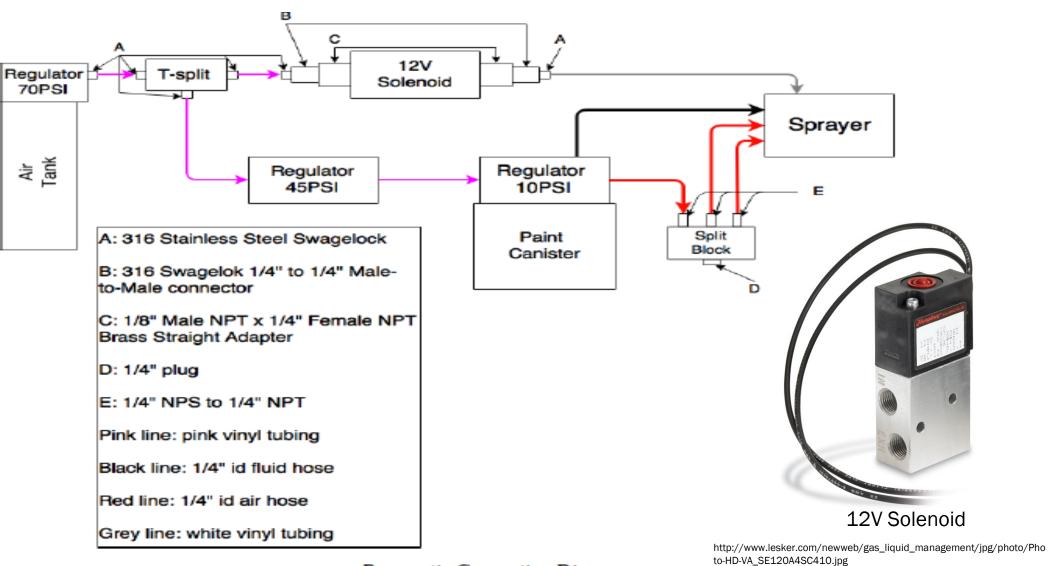
- Full automation capabilities
- More variables to manipulate to adjust spray output

Air cap	Туре	Air Flow		Pressure at inlet		Fluid Flow		Pattern size @ 8" distance	
		SCFM	l/min	psi	bar	oz/min	ml/min	in	mm
SP-100-430-K	Conventional	12	340	50.7	3.5	6.7 - 9.5	200 - 280	7.9	200
SP-100-443-K	Conventional	12.2	345	43.5	3.0	6.7 - 10.1	200 - 300	11.8	300
SP-100-497-K	Conventional	18	510	50.7	3.5	6.7 - 20.2	200 - 600	15.0	380
SP-100-500R-K	HVLP Round Spray	6.8	200	16.0	1.1	.6 - 5.0	20-150	1.6	40
SP-100-507-K	HVLP	19	385	40	1.4	4.4 - 6.5	130 - 190	10.6	270
SP-100-510-K	Trans-Tech	10	283	29	2.0	5.4 - 7.5	160 - 220	10.6	270
SP-100-513-K	Trans-Tech	18.8	531	43.5	3.0	6.7 - 20.2	200 - 600	13.8	350
SP-100-522-K	Trans-Tech	14.5	410	29	2.0	6.7 - 20.2	200 - 600	13.8	350
SP-100-590-K	Trans-Tech	7.7	218	29	2.0	1.6 - 5.0	50 - 150	6.0	150
SP-100-591-K	Trans-Tech	12.3	350	29	2.0	1.7 - 5.1	50 - 150	4.5	115
KK-5090-507 HVLP Test Kit – includes cap, gauge & tube									



http://www.devilbiss.com/Portals/2/Repository/SB-2-584-G.pdf





Pneumatic Connection Diagram





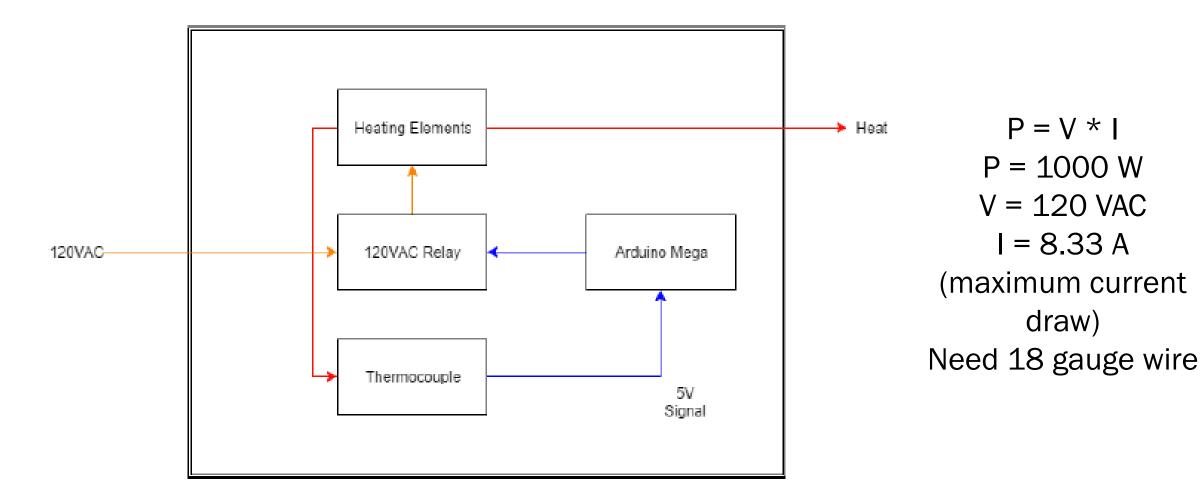


Oven System



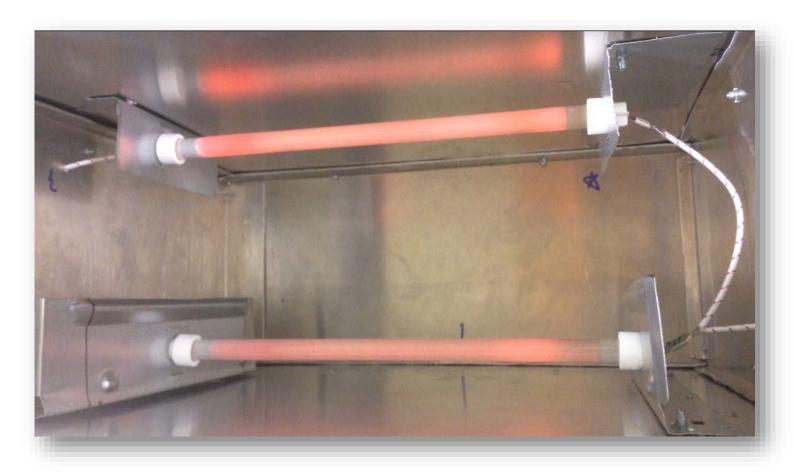
https://www.walmart.com/ip/Mainstays-4-Slice-Toaster-Oven-Black/53986434













UV Exposure System

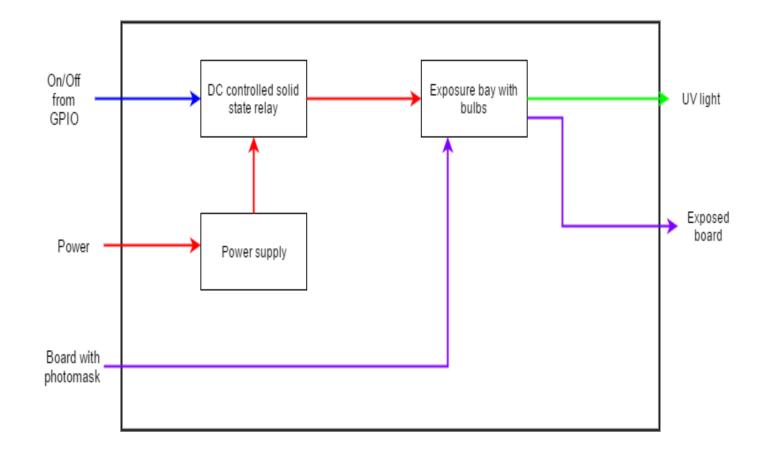
- 72W for 8 Bulbs
- 365-400nm requirement
- Slight modification to accept board frame



http://widgetlove.com/media/catalog/product/cache/1/image/32c3d0b93e1123322b0ba6dc 090e7386/s/k/sku_h776801_1.jpg



UV Exposure





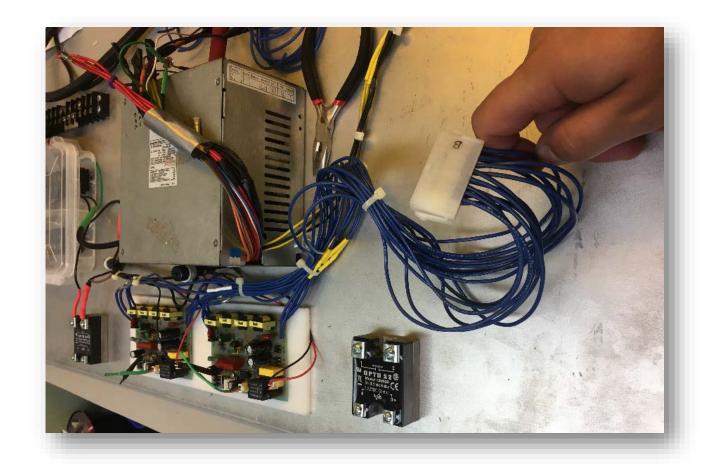
Disassembly





Molex Connector

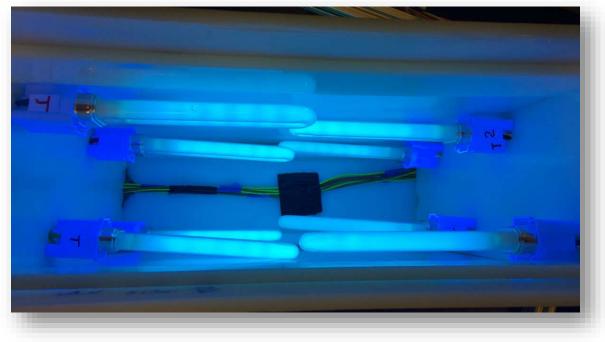
• Easy to disconnect and remove the entire UV system.





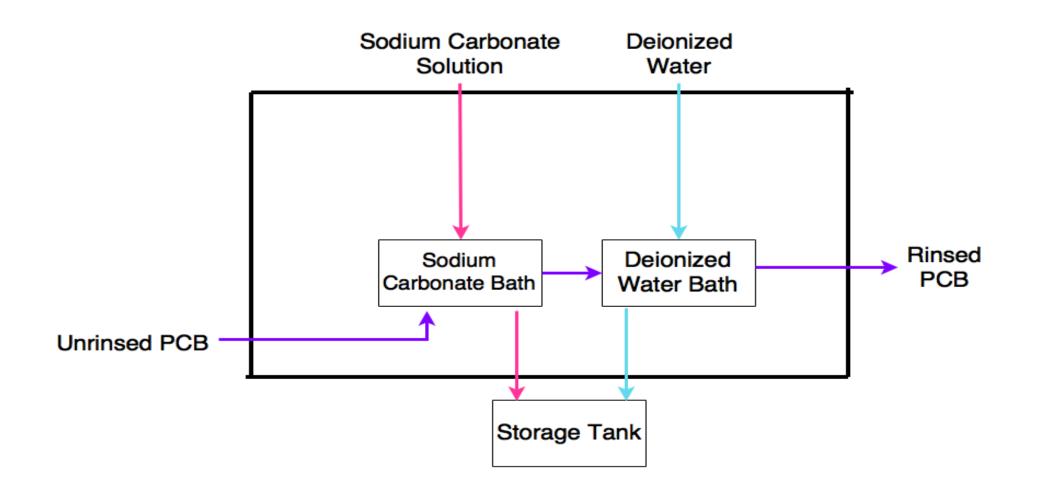
UV Results







Chemical Bath and Rinse Bay





Solution

- The lacquer data sheet called for at least a 1% sodium carbonate solution with a pH of 10.6 or higher.
- We used a soda ash/ water mixture and pH testing strip to achieve these requirements.





Leak Test

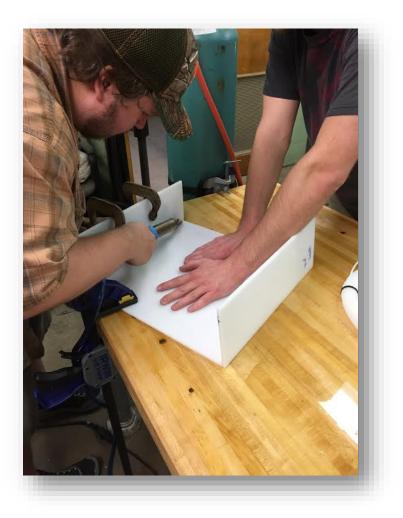




Tank Fabrication



http://www.polyzone.com/media/catalog/product/cache/1/thumbnail/9df78eab33525d08d6e5fb8d27136e95/h/d/hdpe_sheet.jpg





Preliminary Design





Frame Assembly







Frame Components



http://ecx.imagesamazon.com/images/I/519k6gG55sL._SX342_.jpg



https://8020.net/shop/14061.htm

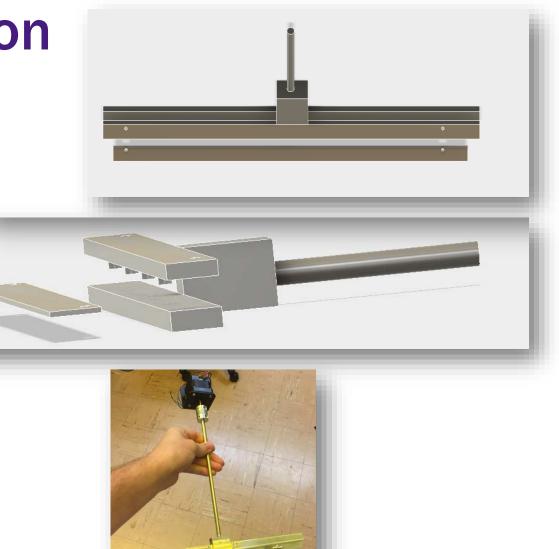


https://8020.net/shop/140 58.html



Miscellaneous Fabrication







Technical specs

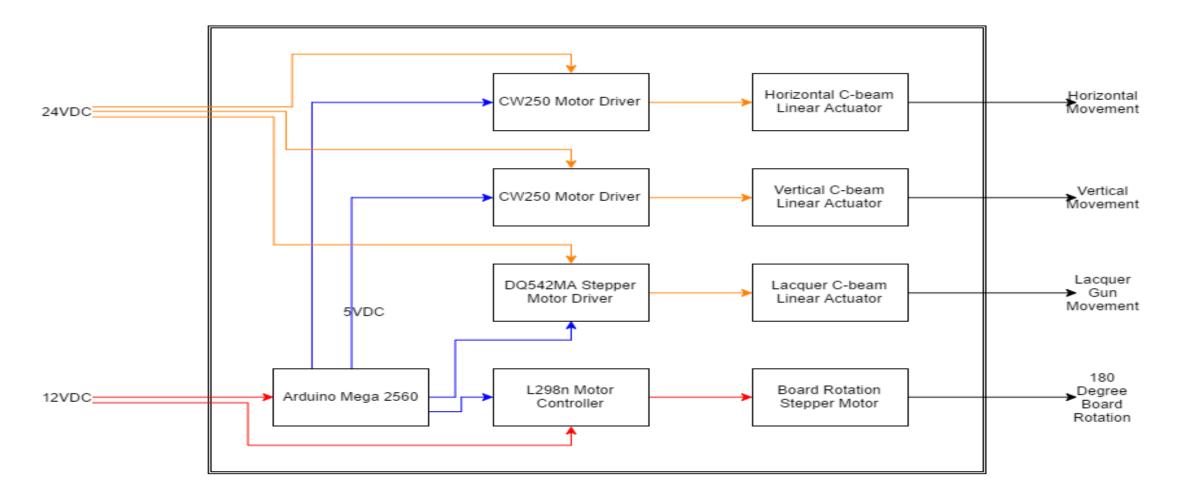
LSU

2016 PCB SMA Group 9 "Fab5"

Microcontroller	ATmega2560	CSP for 16U2 USB interface USB interface
Operating Voltage	5V	Citic
Input Voltage (recommended)	7-12V	
Input Voltage (limit)	6-20V	
Digital I/O Pins	54 (of which 15 provide PWM output)	
Analog Input Pins	16	
DC Current per I/O Pin	20 mA	ATmega2560
DC Current for 3.3V Pin	50 mA	
Flash Memory	256 KB of which 8 KB used by bootloader	
SRAM	8 KB	7 to 12V DC input, POWER ANALOG IN (SPI) SCK 52 53 (SPI) MOSI (SPI) SCK 52 53 (SPI) SS
EEPROM	4 KB	center positive
Clock Speed	16 MHz	und und see
Length	101.52 mm	a dia dia dia dia dia dia dia dia dia di
Width	53.3 mm	
Weight	37 g	https://arduino-info.wikispaces.com/MegaQuickRef



Microcontroller Movement Control





Motor Control

CW250 Driver



https://www.circuitspecialists.com/cw230.html

- DC Power Input: 24V~36V
- DC Current: 0.9A~3.0A
- Logic: 5V (~20mA)

L289N Module



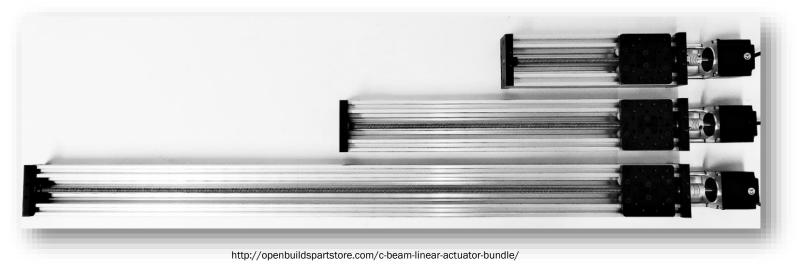
//www.instructables.com/id/Arduino-Modules-L298N-Dual-H-Bridge-Motor-Controll/

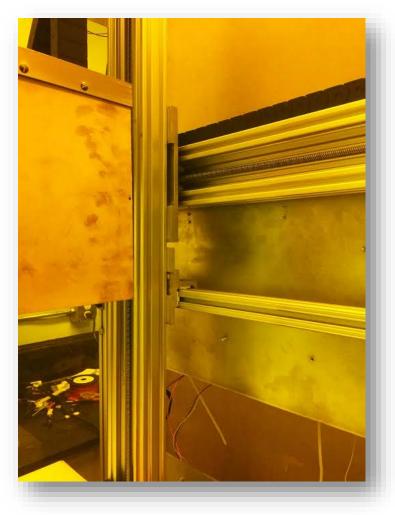
- DC Power Input: 5V~35V
- DC Current: up to 2A
- Logic: 5V (0~36V)



Horizontal and Vertical Movement

- C-Beam 1000mm
- NEMA 23 stepper
- CW250 Driver







PCB Rotation

- NEMA 17 Stepper
- Motor Bracket
- Mounted to C-Beam Arm





http://www.soprolec.com/shop/161-large/stepper-motor-nema-17-022nm.jpg

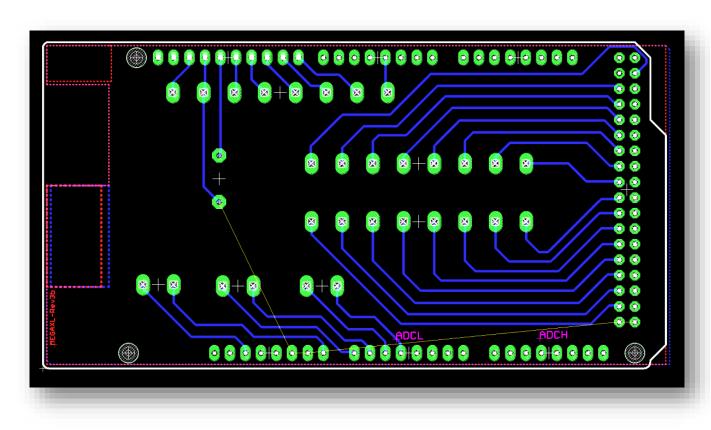


http://www.omc-stepperonline.com/images/st-m1.jpg

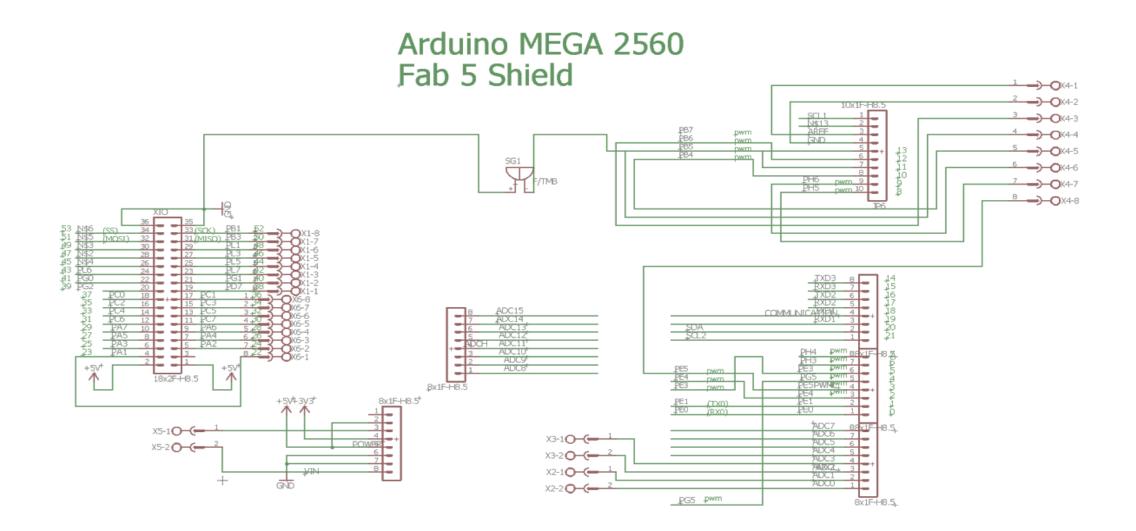


Arduino Shield PCB

- Fits directly on top of Arduino Mega 2560
- Allows phoenix connectors to be used
- Simplifies wiring
- Adds an alarm to the system



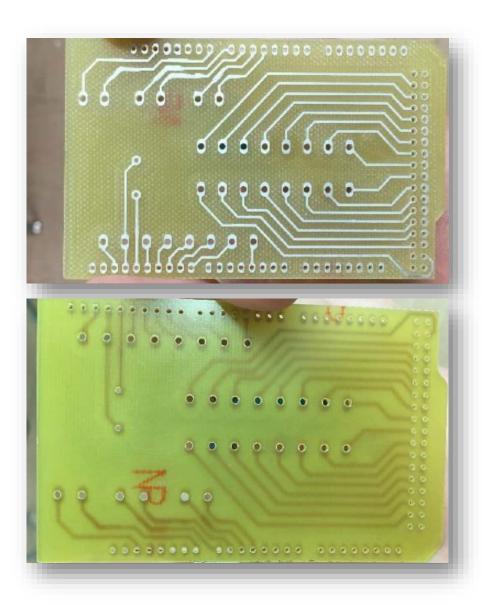






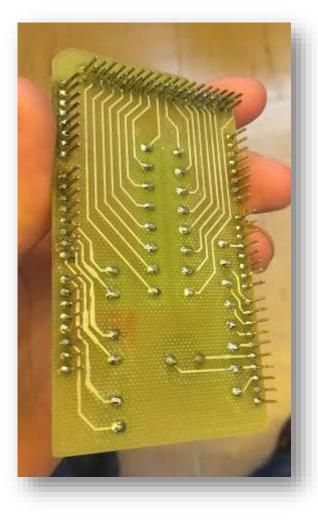
PCB Fabrication

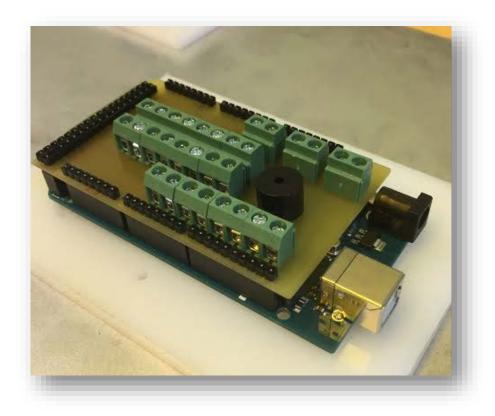
- Milled in EE PCB Fabrication Lab
- Traces tinned to protect from oxidation
- Holes drilled for components



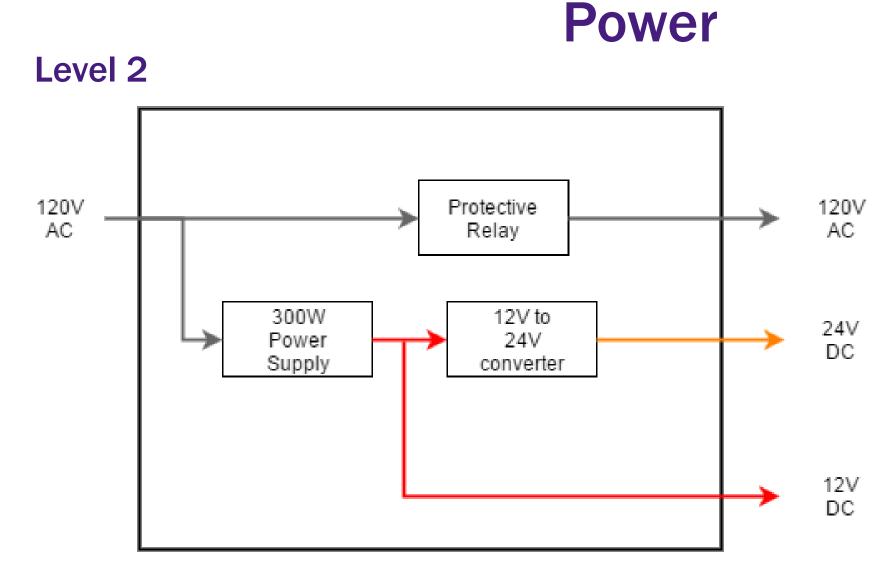


Soldering Components and Fitting









P = I * VP = 20A * 120VP = 2,400W maximum



DC controlled relays

- Opto-22 120VAC 25A SSR
- Opto-22 60VDC 3A
- 3VDC 20mA minimum driving signal
- Mega2560 full control

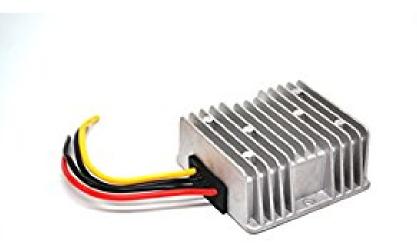


 $http://www.amazon.com/Opto-22-Control-Optical-Isolation/dp/B0058UX2YS/ref=sr_1_6?srs=3445179011 \& ie=UTF8\& qid=1461471509\& sr=8-6\& keywords=dcal_{10} + 1000 keywords=dcal_{$



12-to-24 Voltage Regulator

- Supply 24V for NEMA-23 stepper motors
- Over Voltage and Short Circuit Protection

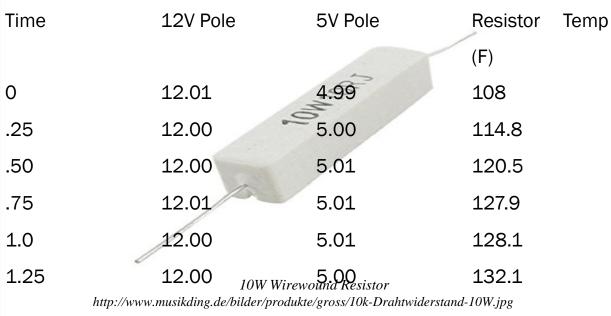


http://ecx.images-amazon.com/images/I/51upUZBHB1L.jpg



300W Power Supply

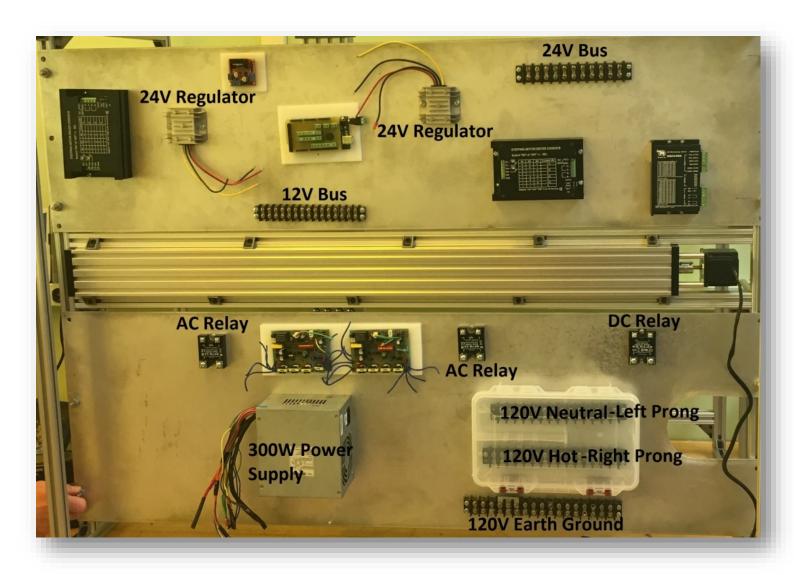






Control Board







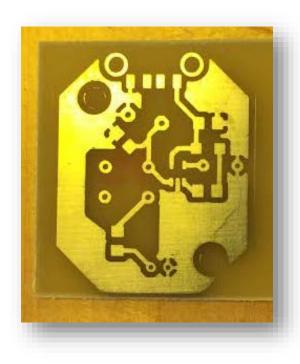
Final Process Specifications

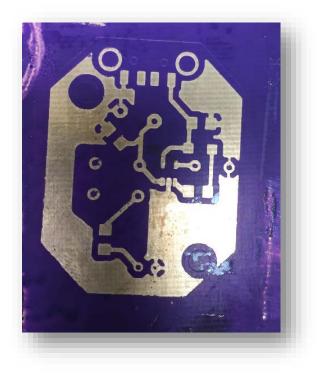
	Left, right, and middle sprayed twice each
Lacquer Application	• Time: ~5 minutes
Application	
	• Heat: ~350F
Oven Tack Dry	• Time: 10 minutes
	• Manual
Photomask Alignment	Time: wait for user to press Continue
	- A bulles are each aide
	• 4 bulbs on each side
UV Exposure	• Time: 30 seconds
	Agitation up and down
Chemical Bath	• Time: 1.5 minutes
Bath	
	Sponges for removal of excess lacquer
Water Rinse	• Time: ~30 seconds
	• Heat: 350F
Oven Curing	• Time: 30 minutes



Results

- Milled and tinned board shown to left
- Solder mask coated board shown to right







Finished Prototype

- Coated in orange acrylic plexiglass
- Vent placed on top to remove fumes
- Self-contained
- Removable front panel for maintenance
- Simple 2-button interface



Budget

- Original budget: \$5000
- Final Expense Total: \$2919.95
- Percentage of Budget Used: 58.4%

ITEM	COST
Lacquer gun setup	\$1,382.90
Lacquer hose fittings	\$59.42
Spare hose	\$29.96
12V solenoid	\$25.98
250mm C-Beam Linear Actuator Bundle	\$121.95
lacquer	\$42.00
Arduino Mega 2560	\$45.95
5V buzzer	\$2.85
CW250 stepper motor driver	\$84.00
DQ542MA stepper motor driver	\$39.95
L298n stepper motor driver	\$6.99
12V barrel plugs	\$6.99
1000mm C-Beam Linear Actuators	\$314.90
Limit switches	\$22.50
MAX6675 k-type thermocouple	\$13.99
Arduino Mega protoshield	\$14.95
Stepper motor coupler	\$8.99
NEMA 17 stepper control	\$38.81
AC Relays	\$87.00
DC Relay	\$17.00
12V-to-24V step-up regulator	\$42.76
20A NEMA plug	\$9.99
8020 aluminum extrusions	\$389.98
M5 screws and t-nuts	\$16.20
UV nail dryers	\$53.98
replacement UV bulbs	\$19.98
toaster oven	\$19.98
TOTAL	\$2,919.95

Lacquer Parts Control Parts Power Parts Structural Parts UV Parts Oven Parts

Performance Outcomes

Goal	Measure of Success	Weight	%	Score
Control of all subsystems	Microprocessor fully controls all motors, actuators, spray, lights, and oven	0.5	80	40
Even exposure of board to UV light	All unwanted lacquer is removed in the chemical rinse and desired mask stays	0.05	95	4.75
Remain within size requirements	Hardware is entirely contained in a 4' tall, 2' deep, and 6-8' long system	0.1	100	10
Solder mask applied evenly	Measured thickness of board after application process should be 2.4-3 mils thicker than before	0.1	70	7
Control heating elements	Elements heat to desired temperature when microprocessor triggers solid-state relay contact to close	0.05	90	4.5
Contain all chemicals	Lacquer, sodium carbonate, and water containers are sealed tight so as not to leak	0.1	95	9.5
Maintainability	All parts are easily replaceable	0.1	80	8
	Total	1.0		83.75



Acknowledgements:

- Professor Scalzo
- Mr. Chris O'Loughlin
- Guoxiang Gu (4810 Mentor)
- Jean-Louis Cozic III
- LSU EE/ECE Department